



# STF24NM60N, STI24NM60N STP24NM60N, STW24NM60N

N-channel 600 V, 0.168  $\Omega$ , 17 A MDmesh™ II Power MOSFET  
TO-220FP, I<sup>2</sup>PAK, TO-220 and TO-247

## Features

| Order codes | V <sub>DSS</sub><br>(@T <sub>jmax</sub> ) | R <sub>DS(on)</sub><br>max. | I <sub>D</sub> |
|-------------|---|-----------------------------|----------------|
| STF24NM60N  | 650 V                                     | < 0.19 $\Omega$             | 17 A           |
| STI24NM60N  | 650 V                                     | < 0.19 $\Omega$             | 17 A           |
| STP24NM60N  | 650 V                                     | < 0.19 $\Omega$             | 17 A           |
| STW24NM60N  | 650 V                                     | < 0.19 $\Omega$             | 17 A           |

- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

## Applications

- Switching applications

## Description

These devices are N-channel Power MOSFETs developed using the second generation of MDmesh™ technology. This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

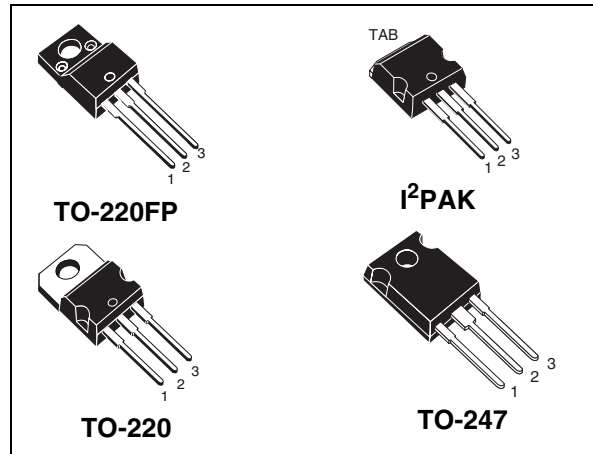


Figure 1. Internal schematic diagram

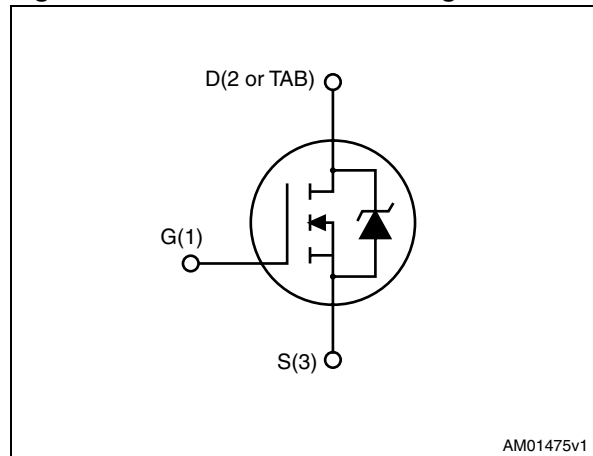


Table 1. Device summary

| Order codes | Marking | Package            | Packaging |
|-------------|---------|--------------------|-----------|
| STF24NM60N  | 24NM60N | TO-220FP           | Tube      |
| STI24NM60N  |         | I <sup>2</sup> PAK |           |
| STP24NM60N  |         | TO-220             |           |
| STW24NM60N  |         | TO-247             |           |

## Contents

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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

| Symbol                             | Parameter  | Value                                  |                   | Unit |
|------------------------------------|--|--|-------------------|------|
|                                    |  | I <sup>2</sup> PAK<br>TO-220<br>TO-247 | TO-220FP          |      |
| V <sub>GS</sub>                    | Gate- source voltage   | ± 30                                   |                   | V    |
| I <sub>D</sub>                     | Drain current (continuous) at T <sub>C</sub> = 25 °C   | 17                                     | 17 <sup>(1)</sup> | A    |
| I <sub>D</sub>                     | Drain current (continuous) at T <sub>C</sub> = 100 °C  | 11                                     | 11 <sup>(1)</sup> | A    |
| I <sub>DM</sub> <sup>(2)</sup>     | Drain current (pulsed)   | 68                                     | 68 <sup>(1)</sup> | A    |
| P <sub>TOT</sub>                   | Total dissipation at T <sub>C</sub> = 25 °C  | 125                                    | 30                | W    |
| dv/dt <sup>(3)</sup>               | Peak diode recovery voltage slope  | 15                                     |                   | V/ns |
| V <sub>ISO</sub>                   | Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T <sub>C</sub> =25 °C) | 2500                                   |                   | V    |
| T <sub>J</sub><br>T <sub>stg</sub> | Operating junction temperature<br>Storage temperature  | -55 to 150                             |                   | °C   |

- Limited only by maximum temperature allowed.
- Pulse width limited by safe operating area.
- $I_{SD} \leq 17$  A,  $di/dt \leq 400$  A/ $\mu$ s, peak  $V_{DS} \leq V_{(BR)DSS}$ ,  $V_{DD} = 80\% V_{(BR)DSS}$

**Table 3. Thermal data**

| Symbol                | Parameter                                      | Value    |                    |        |        | Unit |
|-----------------------|--|----------|--------------------|--------|--------|------|
|                       |  | TO-220FP | I <sup>2</sup> PAK | TO-220 | TO-247 |      |
| R <sub>thj-case</sub> | Thermal resistance junction-case max.          | 4        | 1                  |        |        | °C/W |
| R <sub>thj-amb</sub>  | Thermal resistance junction-ambient max.       | 62.5     |                    |        | 50     | °C/W |
| T <sub>J</sub>        | Maximum lead temperature for soldering purpose | 300      |                    |        |        | °C   |

**Table 4. Avalanche characteristics**

| Symbol          | Parameter  | Value | Unit |
|-----------------|--|-------|------|
| I <sub>AR</sub> | Avalanche current, repetitive or not-repetitive (pulse width limited by T <sub>J</sub> max)                                | 6     | A    |
| E <sub>AS</sub> | Single pulse avalanche energy (starting T <sub>J</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 50 V) | 300   | mJ   |

## 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

**Table 5. On /off states**

| Symbol               | Parameter   | Test conditions   | Min. | Typ.  | Max.     | Unit     |
|----------------------|---|---|------|-------|----------|----------|
| V <sub>(BR)DSS</sub> | Drain-source breakdown voltage (V <sub>GS</sub> = 0)  | I <sub>D</sub> = 1 mA   | 600  |       |          | V        |
| I <sub>DSS</sub>     | Zero gate voltage drain current (V <sub>GS</sub> = 0) | V <sub>DS</sub> = 600 V<br>V <sub>DS</sub> = 600 V, T <sub>C</sub> = 125 °C |      |       | 1<br>100 | μA<br>μA |
| I <sub>GSS</sub>     | Gate-body leakage current (V <sub>DS</sub> = 0)       | V <sub>GS</sub> = ± 25 V  |      |       | 100      | nA       |
| V <sub>GS(th)</sub>  | Gate threshold voltage                                | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA                 | 2    | 3     | 4        | V        |
| R <sub>DS(on)</sub>  | Static drain-source on resistance                     | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 8 A                                |      | 0.168 | 0.19     | Ω        |

**Table 6. Dynamic**

| Symbol                   | Parameter                     | Test conditions   | Min. | Typ. | Max. | Unit |
|--------------------------|-------------------------------|---|------|------|------|------|
| C <sub>iss</sub>         | Input capacitance             | V <sub>DS</sub> = 50 V, f = 1 MHz,<br>V <sub>GS</sub> = 0   | -    | 1400 | -    | pF   |
| C <sub>oss</sub>         | Output capacitance            |   |      | 44   |      | pF   |
| C <sub>rss</sub>         | Reverse transfer capacitance  |   |      | 7.4  |      | pF   |
| C <sub>oss eq. (1)</sub> | Equivalent output capacitance | V <sub>DS</sub> = 0 to 480 V, V <sub>GS</sub> = 0   | -    | 190  | -    | pF   |
| R <sub>g</sub>           | Gate input resistance         | f = 1 MHz open drain  | -    | 5    | -    | Ω    |
| Q <sub>g</sub>           | Total gate charge             | V <sub>DD</sub> = 480 V, I <sub>D</sub> = 17 A,<br>V <sub>GS</sub> = 10 V<br><i>(see Figure 19)</i> | -    | 46   | -    | nC   |
| Q <sub>gs</sub>          | Gate-source charge            |   |      | 7    |      | nC   |
| Q <sub>gd</sub>          | Gate-drain charge             |   |      | 23   |      | nC   |

1. C<sub>o(eff)</sub> is defined as a constant equivalent capacitance giving the same charging time as C<sub>oss</sub> when V<sub>DS</sub> increases from 0 to 80% V<sub>DS</sub>.

**Table 7. Switching times**

| Symbol       | Parameter           | Test conditions   | Min. | Typ. | Max | Unit |
|--------------|---------------------|---|------|------|-----|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 300\text{ V}$ , $I_D = 8.5\text{ A}$ ,<br>$R_G = 4.7\ \Omega$ , $V_{GS} = 10\text{ V}$<br>(see Figure 18) | -    | 11.5 | -   | ns   |
| $t_{r(v)}$   | Voltage rise time   |   |      | 16.5 |     | ns   |
| $t_{d(off)}$ | Turn-off-delay time |   |      | 73   |     | ns   |
| $t_{f(i)}$   | Fall time           |   |      | 37   |     | ns   |

**Table 8. Source drain diode**

| Symbol          | Parameter                     | Test conditions  | Min. | Typ. | Max | Unit          |
|-----------------|-------------------------------|--|------|------|-----|---------------|
| $I_{SD}$        | Source-drain current          |  | -    |      | 17  | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |  |      |      | 68  | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $I_{SD} = 17\text{ A}$ , $V_{GS} = 0$  | -    |      | 1.6 | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 17\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 60\text{ V}$<br>(see Figure 20)                                     | -    | 340  |     | ns            |
| $Q_{rr}$        | Reverse recovery charge       |  |      | 4.6  |     | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |  |      | 27   |     | A             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 17\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$<br>$V_{DD} = 60\text{ V}$ , $T_J = 150\text{ }^\circ\text{C}$<br>(see Figure 20) | -    | 404  |     | ns            |
| $Q_{rr}$        | Reverse recovery charge       |  |      | 5.7  |     | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |  |      | 28   |     | A             |

1. Pulse width limited by safe operating area

2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220FP

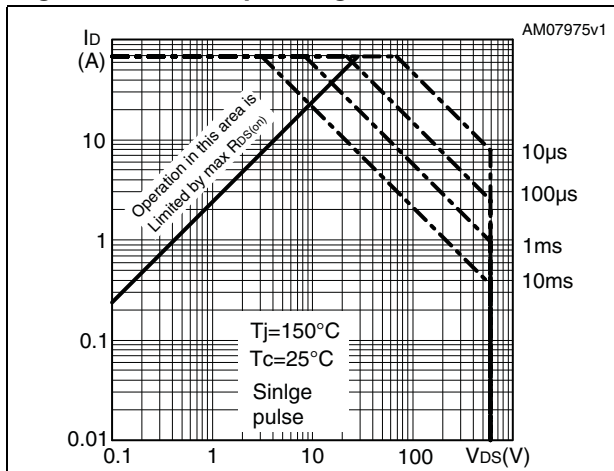


Figure 3. Thermal impedance for TO-220FP

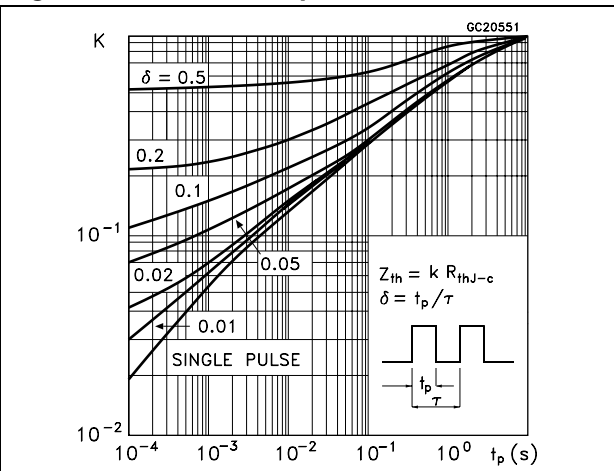


Figure 4. Safe operating area for I<sup>2</sup>PAK and TO-220

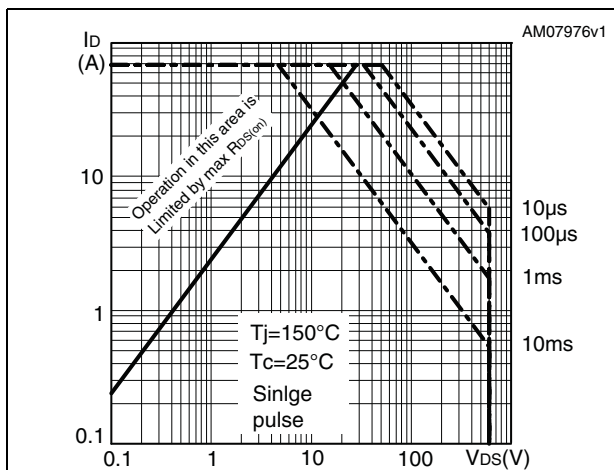


Figure 5. Thermal impedance for I<sup>2</sup>PAK and TO-220

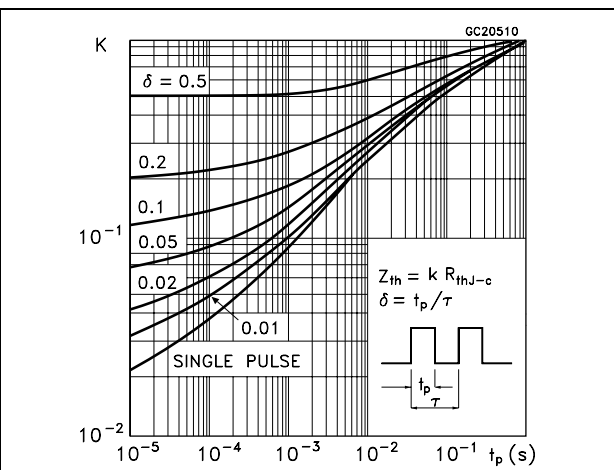


Figure 6. Safe operating area for TO-247

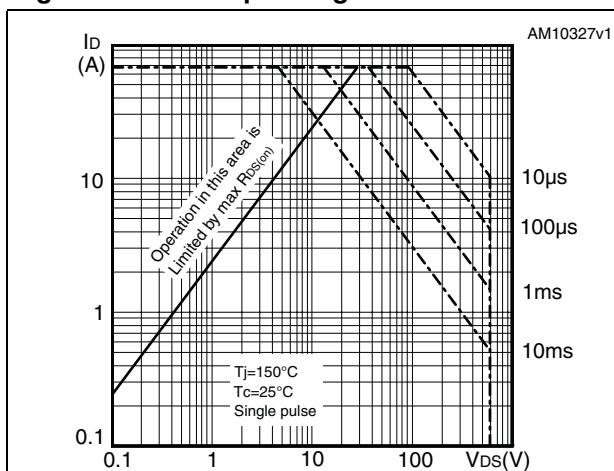


Figure 7. Thermal impedance for TO-247

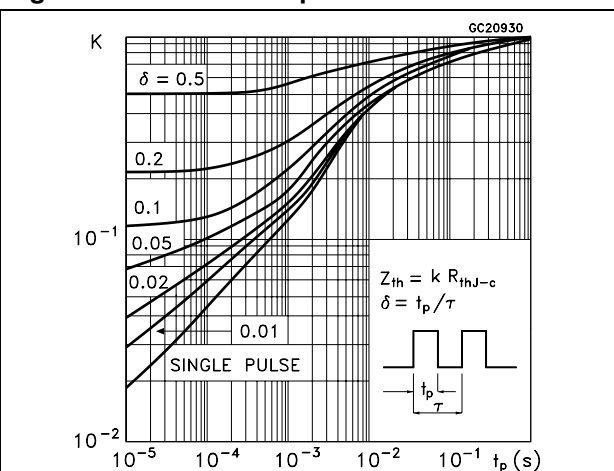


Figure 8. Output characteristics

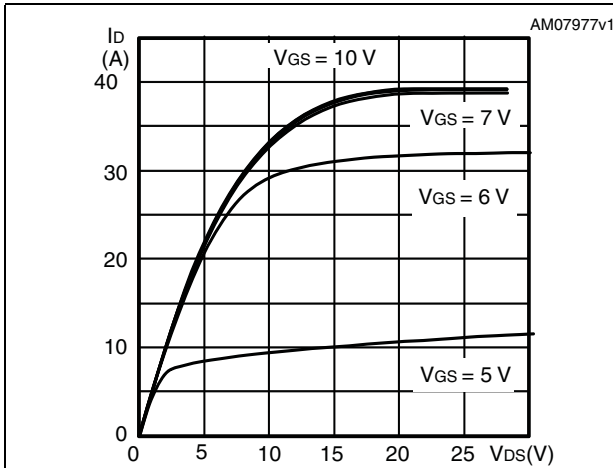


Figure 9. Transfer characteristics

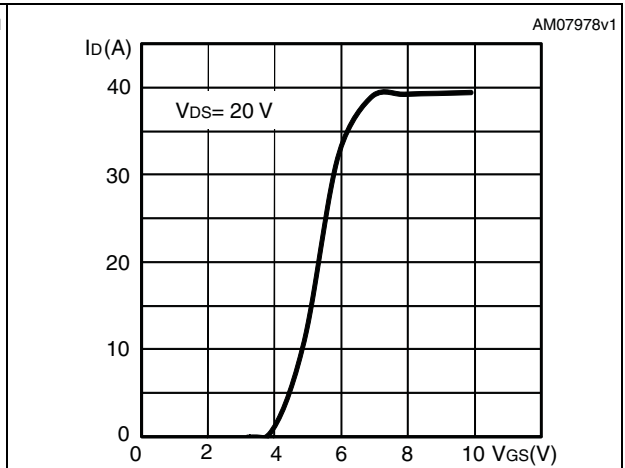


Figure 10. Gate charge vs gate-source voltage Figure 11. Static drain-source on resistance

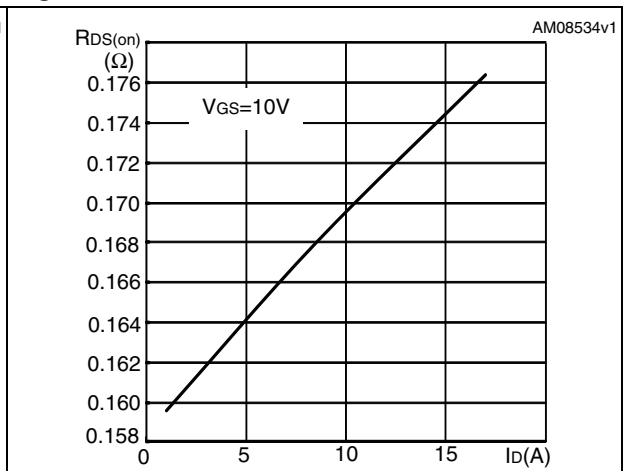
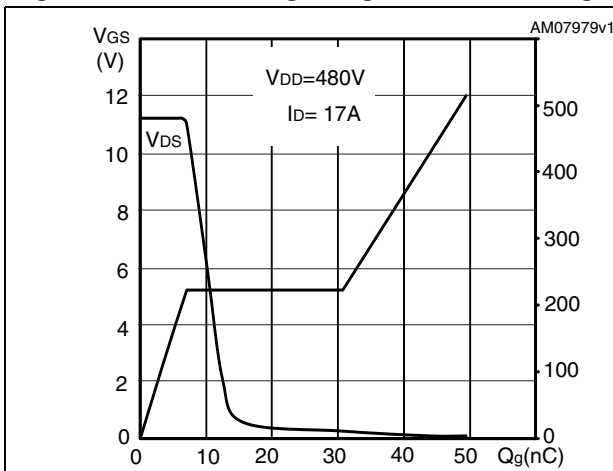


Figure 12. Capacitance variations

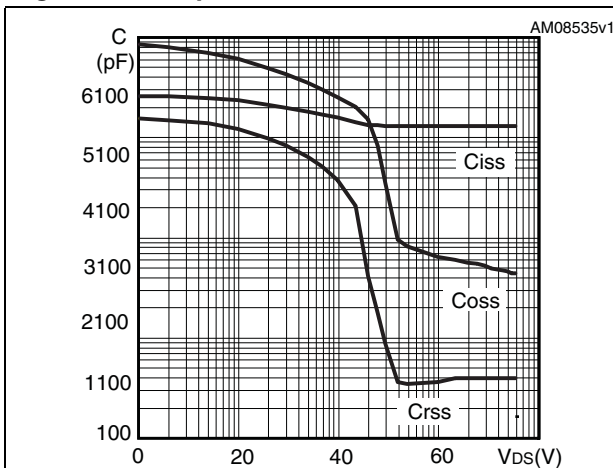


Figure 13. Output capacitance stored energy

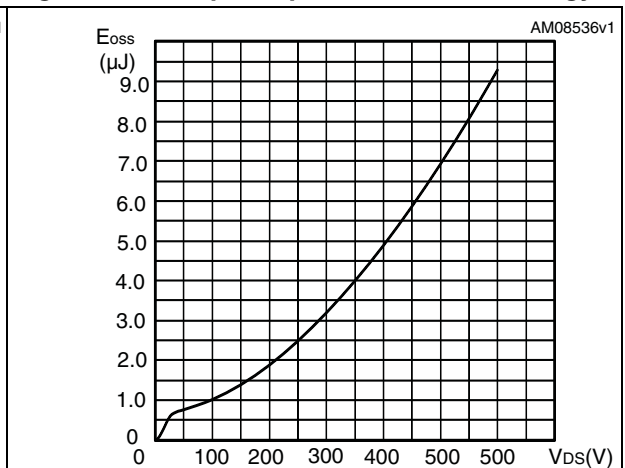


Figure 14. Normalized gate threshold voltage vs temperature

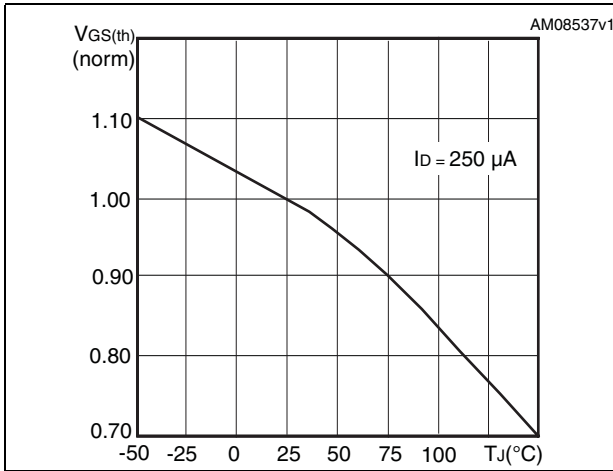


Figure 15. Normalized on resistance vs temperature

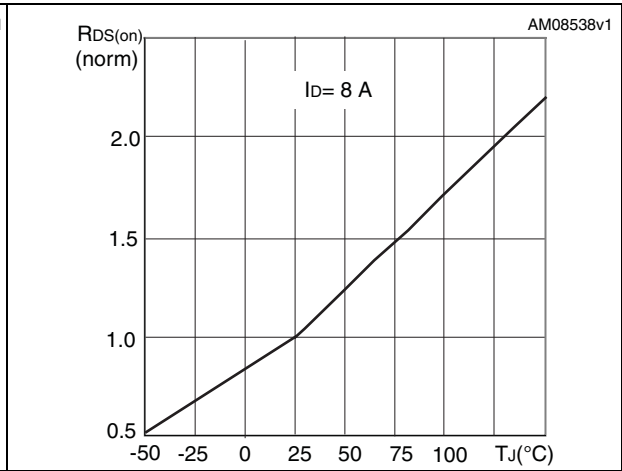


Figure 16. Normalized B<sub>V</sub>DSS vs temperature

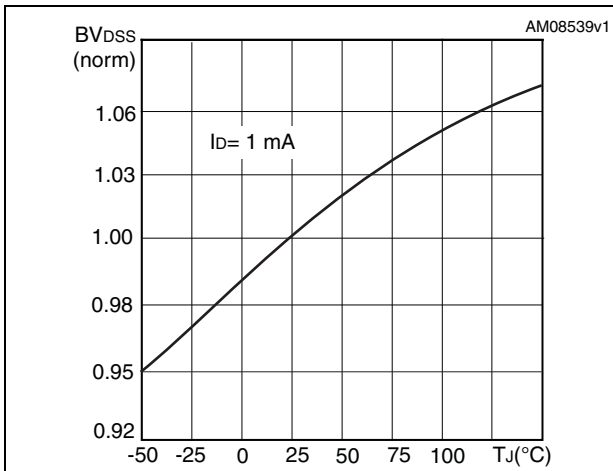
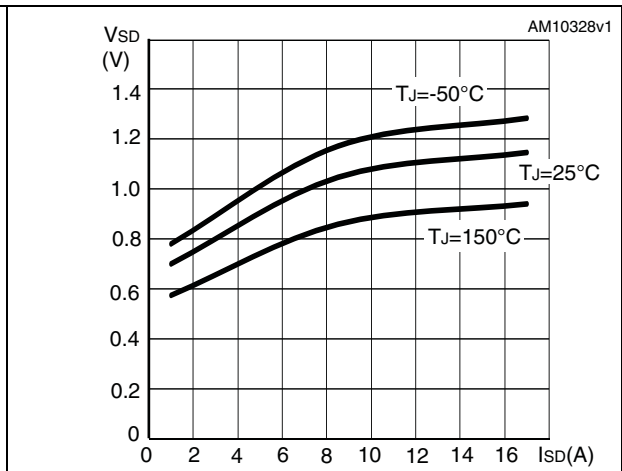


Figure 17. Source-drain diode forward characteristics



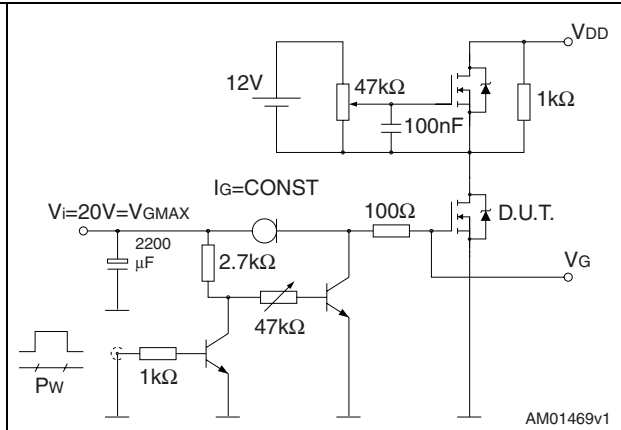


### 3 Test circuits

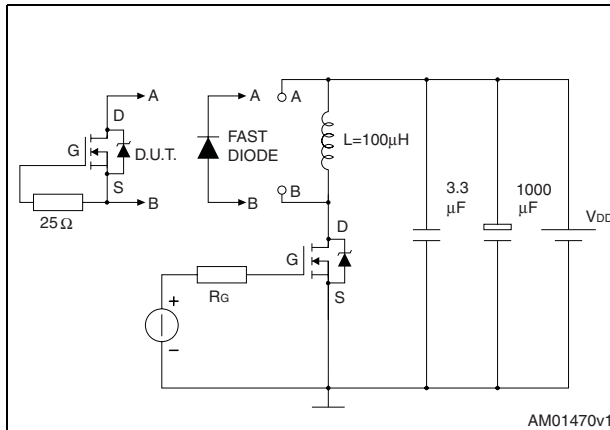
**Figure 18. Switching times test circuit for resistive load**



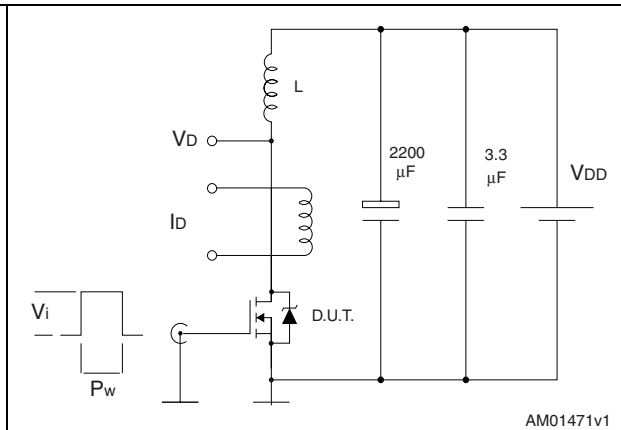
**Figure 19. Gate charge test circuit**



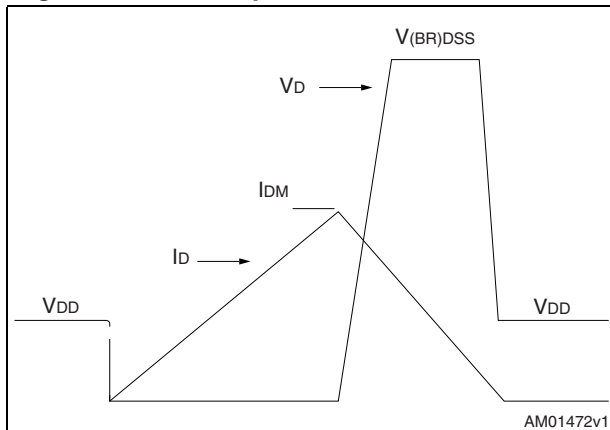
**Figure 20. Test circuit for inductive load switching and diode recovery times**



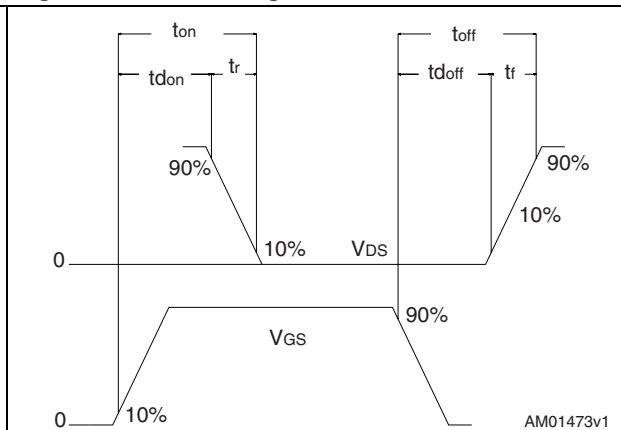
**Figure 21. Unclamped inductive load test circuit**



**Figure 22. Unclamped inductive waveform**



**Figure 23. Switching time waveform**



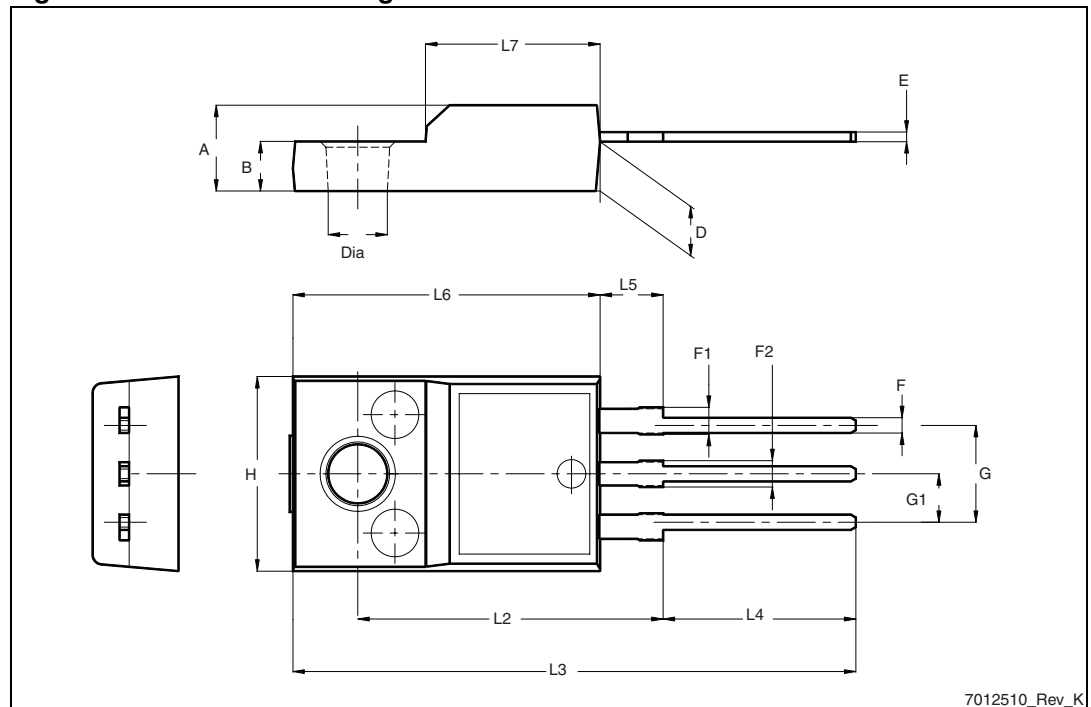
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

Table 9. TO-220FP mechanical data

| Dim. | mm   |      |      |
|------|------|------|------|
|      | Min. | Typ. | Max. |
| A    | 4.4  |      | 4.6  |
| B    | 2.5  |      | 2.7  |
| D    | 2.5  |      | 2.75 |
| E    | 0.45 |      | 0.7  |
| F    | 0.75 |      | 1    |
| F1   | 1.15 |      | 1.70 |
| F2   | 1.15 |      | 1.70 |
| G    | 4.95 |      | 5.2  |
| G1   | 2.4  |      | 2.7  |
| H    | 10   |      | 10.4 |
| L2   |      | 16   |      |
| L3   | 28.6 |      | 30.6 |
| L4   | 9.8  |      | 10.6 |
| L5   | 2.9  |      | 3.6  |
| L6   | 15.9 |      | 16.4 |
| L7   | 9    |      | 9.3  |
| Dia  | 3    |      | 3.2  |

Figure 24. TO-220FP drawing



7012510\_Rev\_K

Table 10. I<sup>2</sup>PAK (TO-262) mechanical data

| DIM. | mm.  |     |       |
|------|------|-----|-------|
|      | min. | typ | max.  |
| A    | 4.40 |     | 4.60  |
| A1   | 2.40 |     | 2.72  |
| b    | 0.61 |     | 0.88  |
| b1   | 1.14 |     | 1.70  |
| c    | 0.49 |     | 0.70  |
| c2   | 1.23 |     | 1.32  |
| D    | 8.95 |     | 9.35  |
| e    | 2.40 |     | 2.70  |
| e1   | 4.95 |     | 5.15  |
| E    | 10   |     | 10.40 |
| L    | 13   |     | 14    |
| L1   | 3.50 |     | 3.93  |
| L2   | 1.27 |     | 1.40  |

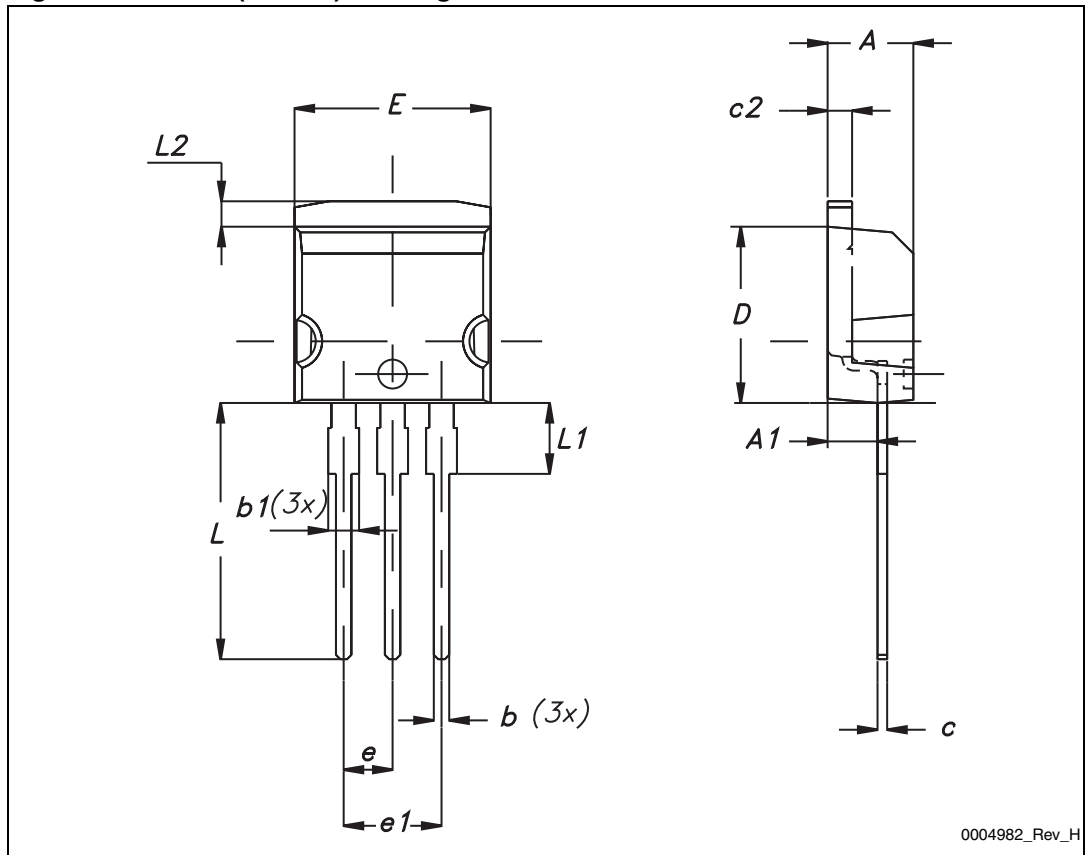
Figure 25. I<sup>2</sup>PAK (TO-262) drawing

Table 11. TO-220 type A mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.40  |       | 4.60  |
| b    | 0.61  |       | 0.88  |
| b1   | 1.14  |       | 1.70  |
| c    | 0.48  |       | 0.70  |
| D    | 15.25 |       | 15.75 |
| D1   |       | 1.27  |       |
| E    | 10    |       | 10.40 |
| e    | 2.40  |       | 2.70  |
| e1   | 4.95  |       | 5.15  |
| F    | 1.23  |       | 1.32  |
| H1   | 6.20  |       | 6.60  |
| J1   | 2.40  |       | 2.72  |
| L    | 13    |       | 14    |
| L1   | 3.50  |       | 3.93  |
| L20  |       | 16.40 |       |
| L30  |       | 28.90 |       |
| ØP   | 3.75  |       | 3.85  |
| Q    | 2.65  |       | 2.95  |

Figure 26. TO-220 type A drawing

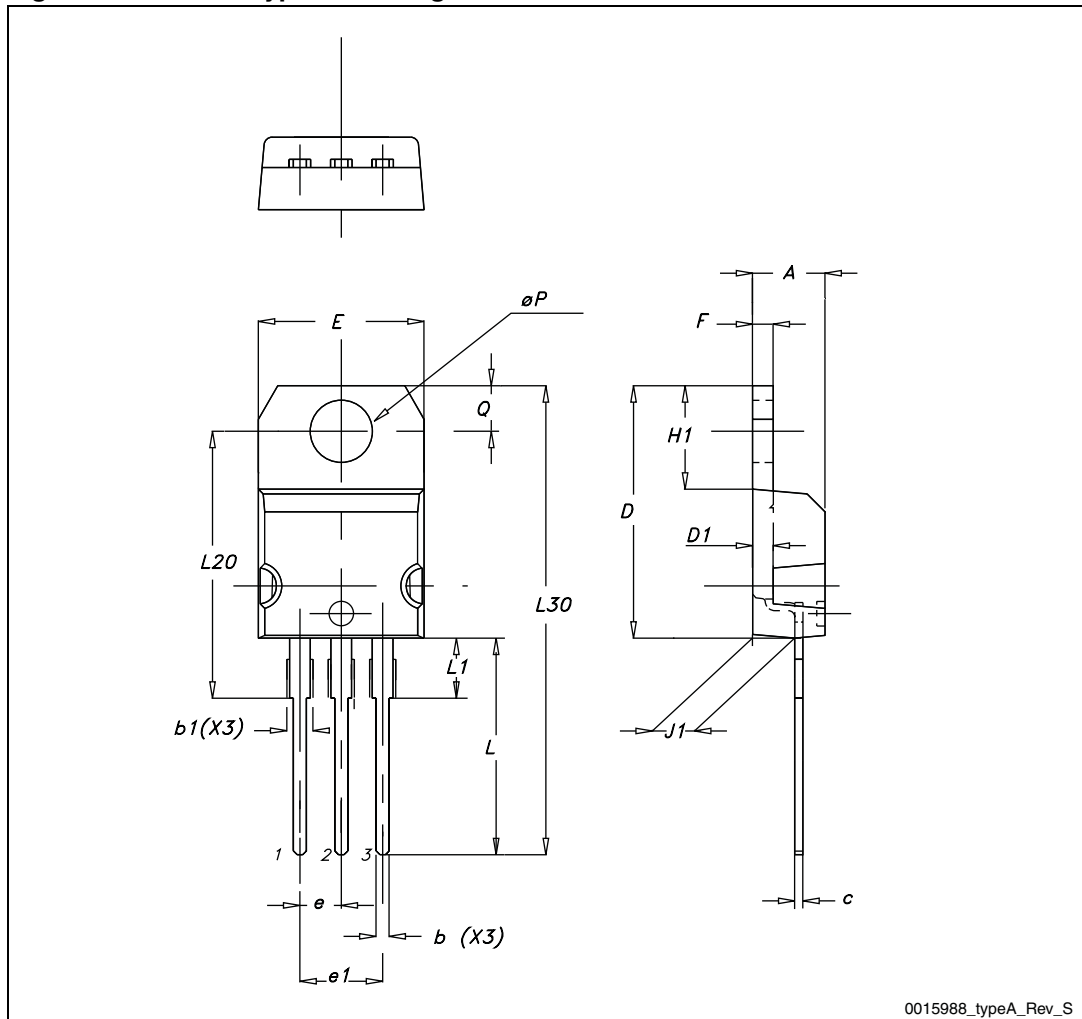
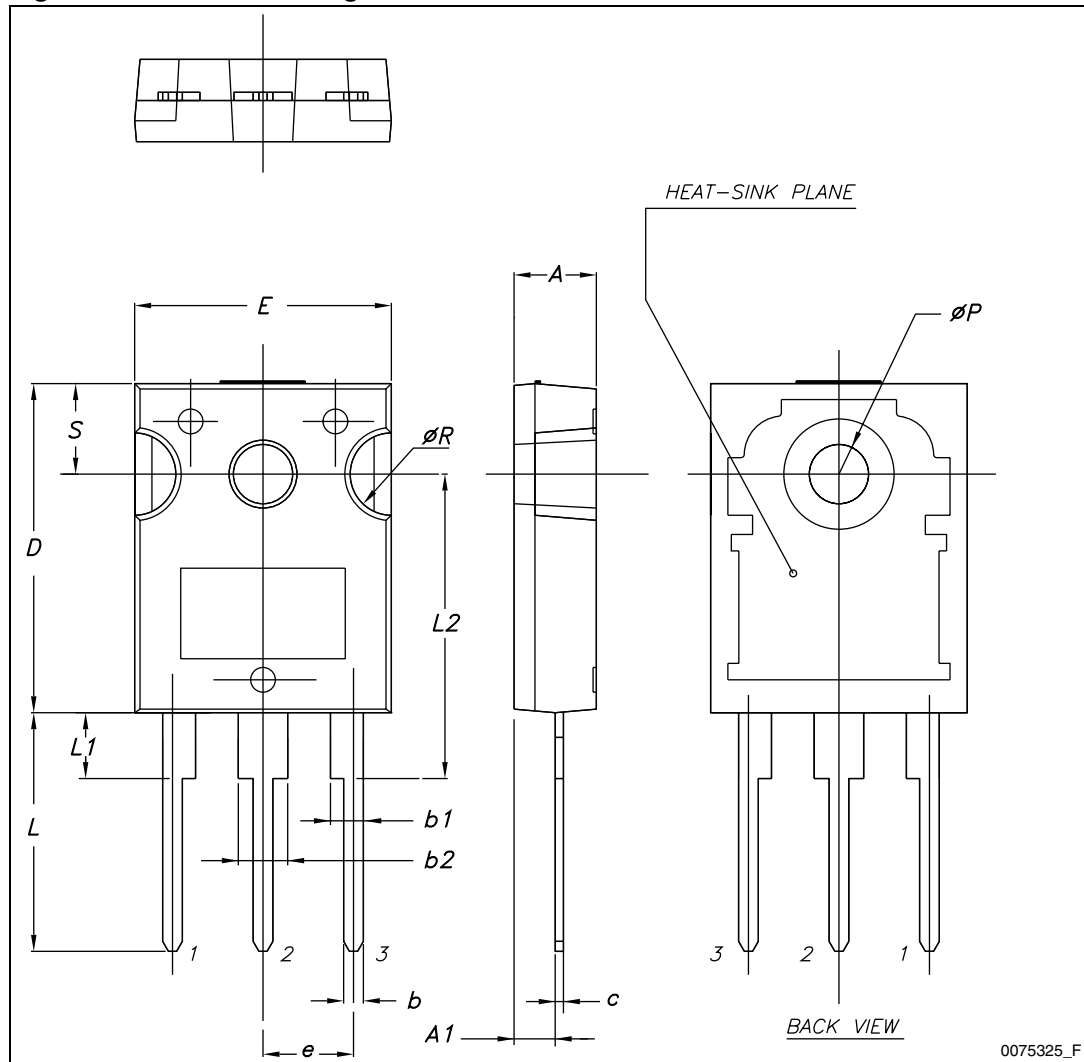


Table 12. TO-247 mechanical data

| Dim. | mm    |       |       |
|------|-------|-------|-------|
|      | Min.  | Typ.  | Max.  |
| A    | 4.85  |       | 5.15  |
| A1   | 2.20  |       | 2.60  |
| b    | 1.0   |       | 1.40  |
| b1   | 2.0   |       | 2.40  |
| b2   | 3.0   |       | 3.40  |
| c    | 0.40  |       | 0.80  |
| D    | 19.85 |       | 20.15 |
| E    | 15.45 |       | 15.75 |
| e    |       | 5.45  |       |
| L    | 14.20 |       | 14.80 |
| L1   | 3.70  |       | 4.30  |
| L2   |       | 18.50 |       |
| ØP   | 3.55  |       | 3.65  |
| ØR   | 4.50  |       | 5.50  |
| S    |       | 5.50  |       |



Figure 27. TO-247 drawing



## 5 Revision history

**Table 13. Document revision history**

| Date        | Revision | Changes   |
|-------------|----------|---|
| 05-Jan-2011 | 1        | First release.  |
| 01-Jul-2011 | 2        | – Corrected $R_{thj-amb}$ value (see <a href="#">Table 3: Thermal data</a> )<br>– Added new package and mechanical data: TO-247.  |
| 22-Aug-2011 | 3        | Inserted device in I <sup>2</sup> PAK:<br>– updated <a href="#">Table 1: Device summary</a> , <a href="#">Table 2: Absolute maximum ratings</a> , <a href="#">Table 3: Thermal data</a><br>– inserted new mechanical data in <a href="#">Section 4: Package mechanical data</a> |

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